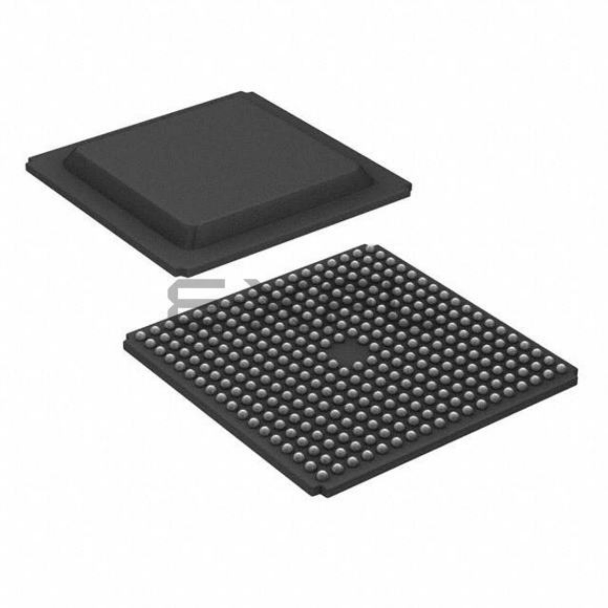
AMD Xilinx - XC3S200A-5FGG320C Datasheet



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Details	
Product Status	Active
Number of LABs/CLBs	448
Number of Logic Elements/Cells	4032
Total RAM Bits	294912
Number of I/O	248
Number of Gates	200000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	320-BGA
Supplier Device Package	320-FBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s200a-5fgg320c

General Recommended Operating Conditions

Table 8: **General Recommended Operating Conditions**

Symbol	Description			Min	Nominal	Max	Units
T_J	Junction temperature	Commercial		0	–	85	°C
		Industrial		–40	–	100	°C
V_{CCINT}	Internal supply voltage			1.14	1.20	1.26	V
V_{CCO}(1)	Output driver supply voltage			1.10	–	3.60	V
V_{CCAUX}	Auxiliary supply voltage(2)	V_{CCAUX} = 2.5		2.25	2.50	2.75	V
		V_{CCAUX} = 3.3		3.00	3.30	3.60	V
V_{IN}	Input voltage(3)	PCI IOSTANDARD		–0.5	–	V_{CCO}+0.5	V
		All other IOSTANDARDs	IP or IO_#	–0.5	–	4.10	V
			IO_Lxxy_#(4)	–0.5	–	4.10	V
T_{IN}	Input signal transition time(5)			–	–	500	ns

Notes:

1. This V_{CCO} range spans the lowest and highest operating voltages for all supported I/O standards. Table 11 lists the recommended V_{CCO} range specific to each of the single-ended I/O standards, and Table 13 lists that specific to the differential standards.
2. Define V_{CCAUX} selection using CONFIG VCCAUX constraint.
3. See XAPP459, "Eliminating I/O Coupling Effects when Interfacing Large-Swing Single-Ended Signals to User I/O Pins."
4. For single-ended signals that are placed on a differential-capable I/O, V_{IN} of –0.2V to –0.5V is supported but can cause increased leakage between the two pins. See *Parasitic Leakage* in UG331, *Spartan-3 Generation FPGA User Guide*.
5. Measured between 10% and 90% V_{CCO}. Follow Signal Integrity recommendations.

Quiescent Current Requirements

Table 10: **Quiescent Supply Current Characteristics**

Symbol	Description	Device	Typical[(2)]	Commercial Maximum[(2)]	Industrial Maximum[(2)]	Units
I_{CCINTQ}	Quiescent V_{CCINT} supply current	XC3S50A	2	20	30	mA
		XC3S200A	7	50	70	mA
		XC3S400A	10	85	125	mA
		XC3S700A	13	120	185	mA
		XC3S1400A	24	220	310	mA
I_{CCOQ}	Quiescent V_{CCO} supply current	XC3S50A	0.2	2	3	mA
		XC3S200A	0.2	2	3	mA
		XC3S400A	0.3	3	4	mA
		XC3S700A	0.3	3	4	mA
		XC3S1400A	0.3	3	4	mA
I_{CCAUXQ}	Quiescent V_{CCAUX} supply current	XC3S50A	3	8	10	mA
		XC3S200A	5	12	15	mA
		XC3S400A	5	18	24	mA
		XC3S700A	6	28	34	mA
		XC3S1400A	10	50	58	mA

Notes:

1. The numbers in this table are based on the conditions set forth in Table 8.
2. Quiescent supply current is measured with all I/O drivers in a high-impedance state and with all pull-up/pull-down resistors at the I/O pads disabled. Typical values are characterized using typical devices at room temperature (T_J of 25°C at V_{CCINT} = 1.2V, V_{CCO} = 3.3V, and V_{CCAUX} = 2.5V). The maximum limits are tested for each device at the respective maximum specified junction temperature and at maximum voltage limits with V_{CCINT} = 1.26V, V_{CCO} = 3.6V, and V_{CCAUX} = 3.6V. The FPGA is programmed with a "blank" configuration data file (that is, a design with no functional elements instantiated). For conditions other than those described above (for example, a design including functional elements), measured quiescent current levels will be different than the values in the table.
3. For more accurate estimates for a specific design, use the Xilinx XPower tools. There are two recommended ways to estimate the total power consumption (quiescent plus dynamic) for a specific design: a) The Spartan-3A FPGA XPower Estimator provides quick, approximate, typical estimates, and does not require a netlist of the design. b) XPower Analyzer uses a netlist as input to provide maximum estimates as well as more accurate typical estimates.
4. The maximum numbers in this table indicate the minimum current each power rail requires in order for the FPGA to power-on successfully.
5. For information on the power-saving Suspend mode, see XAPP480: *Using Suspend Mode in Spartan-3 Generation FPGAs*. Suspend mode typically saves 40% total power consumption compared to quiescent current.

Switching Characteristics

All Spartan-3A FPGAs ship in two speed grades: –4 and the higher performance –5. Switching characteristics in this document are designated as Advance, Preliminary, or Production, as shown in Table 16. Each category is defined as follows:

Advance: These specifications are based on simulations only and are typically available soon after establishing FPGA specifications. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

Preliminary: These specifications are based on complete early silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting preliminary delays is greatly reduced compared to Advance data.

Production: These specifications are approved once enough production silicon of a particular device has been characterized to provide full correlation between speed files and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

Software Version Requirements

Production-quality systems must use FPGA designs compiled using a speed file designated as PRODUCTION status. FPGA designs using a less mature speed file designation should only be used during system prototyping or pre-production qualification. FPGA designs with speed files designated as Advance or Preliminary should not be used in a production-quality system.

Whenever a speed file designation changes, as a device matures toward Production status, rerun the latest Xilinx® ISE® software on the FPGA design to ensure that the FPGA design incorporates the latest timing information and software updates.

All parameter limits are representative of worst-case supply voltage and junction temperature conditions. **Unless otherwise noted, the published parameter values apply to all Spartan-3A devices. AC and DC characteristics are specified using the same numbers for both commercial and industrial grades.**

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Timing parameters and their representative values are selected for inclusion below either because they are important as general design requirements or they indicate fundamental device performance characteristics. The Spartan-3A FPGA speed files (v1.41), part of the Xilinx Development Software, are the original source for many but not all of the values. The speed grade designations for these files are shown in Table 16. For more complete, more precise, and worst-case data, use the values reported by the Xilinx static timing analyzer (TRACE in the Xilinx development software) and back-annotated to the simulation netlist.

Table 16: **Spartan-3A v1.41 Speed Grade Designation**

Device	Advance	Preliminary	Production
XC3S50A			-4, -5
XC3S200A			-4, -5
XC3S400A			-4, -5
XC3S700A			-4, -5
XC3S1400A			-4, -5

Table 17 provides the recent history of the Spartan-3A FPGA speed files.

Table 17: **Spartan-3A Speed File Version History**

Version	ISE Release	Description
1.41	ISE 10.1.03	Updated Automotive output delays
1.40	ISE 10.1.02	Updated Automotive input delays.
1.39	ISE 10.1.01	Added Automotive parts.
1.38	ISE 9.2.03i	Added Absolute Minimum values.
1.37	ISE 9.2.01i	Updated pin-to-pin setup and hold times (Table 19), TMDS output adjustment (Table 26) multiplier setup/hold times (Table 34), and block RAM clock width (Table 35).
1.36	ISE 9.2i; previously available via Answer Record AR24992	XC3S400A, all speed grades and all temperature grades, upgraded to Production
1.35	Answer Record AR24992	XC3S50A, XC3S200A, XC3S700A, XC3S1400A, all speed grades and all temperature grades, upgraded to Production.
1.34	ISE 9.1.03i	XC3S700A and XC3S1400A -4 speed grade upgraded to Production. Updated pin-to-pin timing numbers.

Table 20: **Setup and Hold Times for the IOB Input Path*(Continued)***

Symbol	Description	Conditions	IFD_ DELAY_ VALUE	Device	Speed Grade -5 Min	Speed Grade -4 Min	Units
$T_{IOICKPD}$	Time from the active transition at the ICLK input of the Input Flip-Flop (IFF) to the point where data must be held at the Input pin. The Input Delay is programmed.	LVCMOS25[3]	1	XC3S400A	–1.12	–1.12	ns
			2		–1.70	–1.70	ns
			3		–2.08	–2.08	ns
			4		–2.38	–2.38	ns
			5		–2.23	–2.23	ns
			6		–2.69	–2.69	ns
			7		–3.08	–3.08	ns
			8		–3.35	–3.35	ns
			1	XC3S700A	–1.67	–1.67	ns
			2		–2.27	–2.27	ns
			3		–2.59	–2.59	ns
			4		–2.92	–2.92	ns
			5		–2.89	–2.89	ns
			6		–3.22	–3.22	ns
			7		–3.52	–3.52	ns
			8		–3.81	–3.81	ns
			1	XC3S1400A	–1.60	–1.60	ns
			2		–2.06	–2.06	ns
			3		–2.46	–2.46	ns
			4		–2.86	–2.86	ns
			5		–2.88	–2.88	ns
			6		–3.24	–3.24	ns
			7		–3.55	–3.55	ns
			8		–3.89	–3.89	ns
Set/Reset Pulse Width							
T_{RPW_IOB}	Minimum pulse width to SR control input on IOB	-	-	All	1.33	1.61	ns

Notes:

1. The numbers in this table are tested using the methodology presented in Table 27 and are based on the operating conditions set forth in Table 8 and Table 11.
2. This setup time requires adjustment whenever a signal standard other than LVCMOS25 is assigned to the data Input. If this is true, add the appropriate Input adjustment from Table 23.
3. These hold times require adjustment whenever a signal standard other than LVCMOS25 is assigned to the data Input. If this is true, subtract the appropriate Input adjustment from Table 23. When the hold time is negative, it is possible to change the data before the clock's active edge.

Table 21: **Sample Window (Source Synchronous)**

Symbol	Description	Max	Units
T_{SAMP}	Setup and hold capture window of an IOB flip-flop.	The input capture sample window value is highly specific to a particular application, device, package, I/O standard, I/O placement, DCM usage, and clock buffer. Please consult the appropriate Xilinx Answer Record for application-specific values. • Answer Record 30879	ps

Output Timing Adjustments

Table 26: **Output Timing Adjustments for IOB**

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
Single-Ended Standards					
LVTTL	Slow	2 mA	5.58	5.58	ns
		4 mA	3.16	3.16	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.62	1.62	ns
		16 mA	1.24	1.24	ns
		24 mA	2.74(3)	2.74(3)	ns
	Fast	2 mA	3.03	3.03	ns
		4 mA	1.71	1.71	ns
		6 mA	1.71	1.71	ns
		8 mA	0.53	0.53	ns
		12 mA	0.53	0.53	ns
		16 mA	0.59	0.59	ns
		24 mA	0.60	0.60	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.67	16.67	ns
		16 mA	16.22	16.22	ns
		24 mA	12.11	12.11	ns
LVCMOS33	Slow	2 mA	5.58	5.58	ns
		4 mA	3.17	3.17	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.24	1.24	ns
		16 mA	1.15	1.15	ns
		24 mA	2.55(3)	2.55(3)	ns
	Fast	2 mA	3.02	3.02	ns
		4 mA	1.71	1.71	ns
		6 mA	1.72	1.72	ns
		8 mA	0.53	0.53	ns
		12 mA	0.59	0.59	ns
		16 mA	0.59	0.59	ns
		24 mA	0.51	0.51	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.29	16.29	ns
		16 mA	16.18	16.18	ns
		24 mA	12.11	12.11	ns

Configurable Logic Block (CLB) Timing

Table 30: **CLB (SLICEM) Timing**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{CKO}	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	–	0.60	–	0.68	ns
Setup Times						
T_{AS}	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.18	–	0.36	–	ns
T_{DICK}	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.58	–	1.88	–	ns
Hold Times						
T_{AH}	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	–	0	–	ns
T_{CKDI}	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0	–	0	–	ns
Clock Timing						
T_{CH}	The High pulse width of the CLB's CLK signal	0.63	–	0.75	–	ns
T_{CL}	The Low pulse width of the CLK signal	0.63	–	0.75	–	ns
F_{TOG}	Toggle frequency (for export control)	0	770	0	667	MHz
Propagation Times						
T_{ILO}	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	–	0.62	–	0.71	ns
Set/Reset Pulse Width						
T_{RPW_CLB}	The minimum allowable pulse width, High or Low, to the CLB's SR input	1.33	–	1.61	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

18 x 18 Embedded Multiplier Timing

Table 34: **18 x 18 Embedded Multiplier Timing**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Combinatorial Delay						
T_{MULT}	Combinational multiplier propagation delay from the A and B inputs to the P outputs, assuming 18-bit inputs and a 36-bit product (AREG, BREG, and PREG registers unused)	–	4.36	–	4.88	ns
Clock-to-Output Times						
T_{MSCKP_P}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using the PREG register(2,3)	–	0.84	–	1.30	ns
T_{MSCKP_A} T_{MSCKP_B}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using either the AREG or BREG register(2,4)	–	4.44	–	4.97	ns
Setup Times						
T_{MSDCK_P}	Data setup time at the A or B input before the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused)(3)	3.56	–	3.98	–	ns
T_{MSDCK_A}	Data setup time at the A input before the active transition at the CLK when using the AREG input register(4)	0.00	–	0.00	–	ns
T_{MSDCK_B}	Data setup time at the B input before the active transition at the CLK when using the BREG input register(4)	0.00	–	0.00	–	ns
Hold Times						
T_{MSCKD_P}	Data hold time at the A or B input after the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused)(3)	0.00	–	0.00	–	ns
T_{MSCKD_A}	Data hold time at the A input after the active transition at the CLK when using the AREG input register(4)	0.35	–	0.45	–	ns
T_{MSCKD_B}	Data hold time at the B input after the active transition at the CLK when using the BREG input register(4)	0.35	–	0.45	–	ns
Clock Frequency						
F_{MULT}	Internal operating frequency for a two-stage 18x18 multiplier using the AREG and BREG input registers and the PREG output register(1)	0	280	0	250	MHz

Notes:

1. Combinational delay is less and pipelined performance is higher when multiplying input data with less than 18 bits.
2. The PREG register is typically used in both single-stage and two-stage pipelined multiplier implementations.
3. The PREG register is typically used when inferring a single-stage multiplier.
4. Input registers AREG or BREG are typically used when inferring a two-stage multiplier.
5. The numbers in this table are based on the operating conditions set forth in Table 8.

Phase Shifter (PS)

Table 40: **Recommended Operating Conditions for the PS in Variable Phase Mode**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Operating Frequency Ranges						
PSCLK_FREQ (F_{PSCLK})	Frequency for the PSCLK input	1	167	1	167	MHz
Input Pulse Requirements						
PSCLK_PULSE	PSCLK pulse width as a percentage of the PSCLK period	40%	60%	40%	60%	-

Table 41: **Switching Characteristics for the PS in Variable Phase Mode**

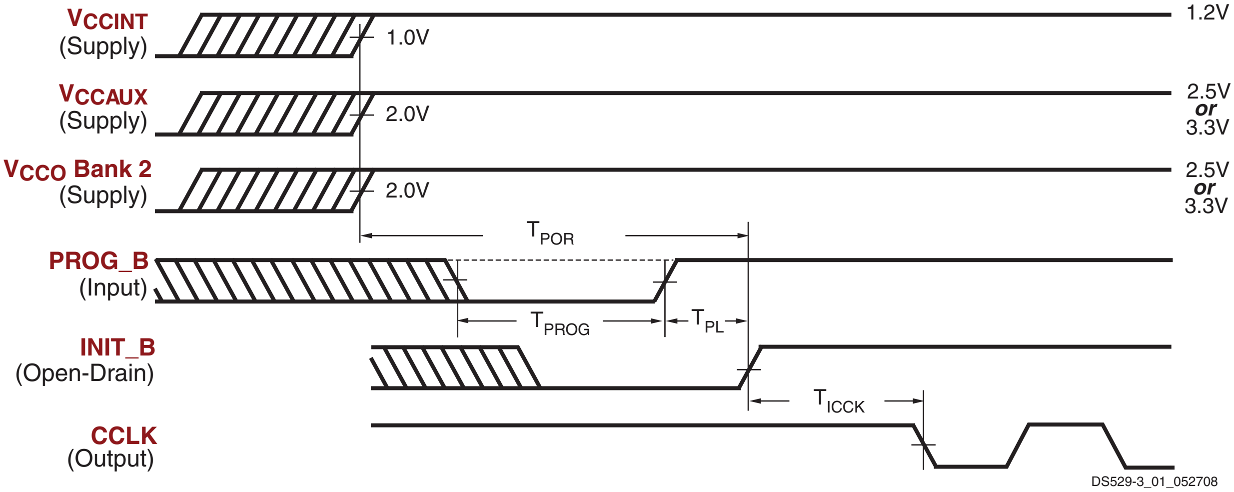
Symbol	Description		Phase Shift Amount	Units
Phase Shifting Range				
MAX_STEPS(2)	Maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. If using CLKIN_DIVIDE_BY_2 = TRUE, double the clock effective clock period.	CLKIN < 60 MHz	±[INTEGER(10 • (T_{CLKIN} – 3 ns))]	steps
		CLKIN ≥ 60 MHz	±[INTEGER(15 • (T_{CLKIN} – 3 ns))]	
FINE_SHIFT_RANGE_MIN	Minimum guaranteed delay for variable phase shifting		±[MAX_STEPS • DCM_DELAY_STEP_MIN]	ns
FINE_SHIFT_RANGE_MAX	Maximum guaranteed delay for variable phase shifting		±[MAX_STEPS • DCM_DELAY_STEP_MAX]	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8 and Table 40.
2. The maximum variable phase shift range, MAX_STEPS, is only valid when the DCM is has no initial fixed phase shifting, that is, the PHASE_SHIFT attribute is set to 0.
3. The DCM_DELAY_STEP values are provided at the bottom of Table 37.

Configuration and JTAG Timing

General Configuration Power-On/Reconfigure Timing



Notes:

1. The V_{CCINT}, V_{CCAUX}, and V_{CCO} supplies can be applied in any order.
2. The Low-going pulse on PROG_B is optional after power-on but necessary for reconfiguration without a power cycle.
3. The rising edge of INIT_B samples the voltage levels applied to the mode pins (M0 - M2).

Figure 11: **Waveforms for Power-On and the Beginning of Configuration**

Table 45: **Power-On Timing and the Beginning of Configuration**

Symbol	Description	Device	All Speed Grades		Units
			Min	Max	
T_{POR}(2)	The time from the application of V_{CCINT}, V_{CCAUX}, and V_{CCO} Bank 2 supply voltage ramps (whichever occurs last) to the rising transition of the INIT_B pin	All	–	18	ms
T_{PROG}	The width of the low-going pulse on the PROG_B pin	All	0.5	-	µs
T_{PL}(2)	The time from the rising edge of the PROG_B pin to the rising transition on the INIT_B pin	XC3S50A	–	0.5	ms
		XC3S200A	–	0.5	ms
		XC3S400A	–	1	ms
		XC3S700A	–	2	ms
		XC3S1400A	–	2	ms
T_{INIT}	Minimum Low pulse width on INIT_B output	All	250	–	ns
T_{ICCK}(3)	The time from the rising edge of the INIT_B pin to the generation of the configuration clock signal at the CCLK output pin	All	0.5	4	µs

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8. This means power must be applied to all V_{CCINT}, V_{CCO}, and V_{CCAUX} lines.
2. Power-on reset and the clearing of configuration memory occurs during this period.
3. This specification applies only to the Master Serial, SPI, and BPI modes.
4. For details on configuration, see UG332 *Spartan-3 Generation Configuration User Guide*.

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Moved Table 15 to under "DC Electrical Characteristics" section. Updated all timing specifications for the v1.32 speed files. Added recommended Simultaneous Switching Output (SSO) limits in Table 29. Set a 10 µs maximum pulse width for the DNA_PORT READ signal and the JTAG clock input during the ISC_DNA command, affecting both Table 43 and Table 56. Described "External Termination Requirements for Differential I/O." Added separate DIN hold time for Slave mode in Table 50. Corrected wording in Table 52 and Table 54; no specifications affected.
03/16/07	1.2	Updated all AC timing specifications to the v1.34 speeds file. Promoted the XC3S700A and XC3S1400A FPGAs offered in the -4 speed grade to Production status, as shown in Table 16. Added Note 2 to Table 39 regarding the extra logic (one LUT) automatically added by ISE 9.1i and later software revisions for any DCM application that leverages the Digital Frequency Synthesizer (DFS). Separated some JTAG specifications by array size or function, as shown in Table 56. Updated quiescent current limits in Table 10.
04/23/07	1.3	Updated all AC timing specifications to the v1.35 speeds file. Promoted all devices except the XC3S400A to Production status, as shown in Table 16.
05/08/07	1.4	Updated XC3S400A to Production and v1.36 speeds file. Added banking rules and other explanatory footnotes to Table 12 and Table 13. Corrected DIFF_SSTL3_II V_{OL} Max in Table 14. Improved XC3S400A Pin-to-Pin Clock-to-Output times in Table 18. Updated XC3S400A Pin-to-Pin Setup Times in Table 19. Updated TIOICKPD for -5 in Table 20. Added SSO numbers to Table 28 and Table 29. Removed invalid Embedded Multiplier Hold Times in Table 34. Improved CLKOUT_FREQ_CLK90 in Table 37. Improved T_{TDITCK} and F_{TCK} performance for XC3S400A in Table 56.
07/10/07	1.5	Added DIFF_HSTL_I and DIFF_HSTL_III to Table 13, Table 14, Table 27, and Table 29. Updated TMDS DC characteristics in Table 14. Updated for speed file v1.37 in ISE 9.2.01i as shown in Table 17. Updated pin-to-pin setup and hold times in Table 19. Updated TMDS output adjustment in Table 26. Updated I/O Test Method values in Table 27. Added BLVDS SSO numbers inTable 29. For Multiplier block, updated setup times and added hold times to Table 34. Updated block RAM clock width in Table 35. Updated CLKOUT_PER_JITT_2X and CLKOUT_PER_JITT_DV2 in Table 37. Added CCLK specifications for Commercial in Table 46 through Table 48.
04/15/08	1.6	Added V_{IN} to Recommended Operating Conditions in Table 8 and added reference to XAPP459, “Eliminating I/O Coupling Effects when Interfacing Large-Swing Single-Ended Signals to User I/O Pins.” Reduced typical I_{CCINTQ} and I_{CCAUXQ} quiescent current values by 12%-58% in Table 10. Increased V_{IL} max to 0.4V for LVCMOS12/15/18 and improved V_{IH} min to 0.7V for LVCMOS12 in Table 11. Changed V_{OL} max to 0.4V and V_{OH} min to V_{CCO}-0.4V for LVCMOS15/18 in Table 12. Noted latest speed file v1.39 in ISE 10.1 software in Table 16. Added new packages to SSO limits in Table 28 and Table 29. Improved SSTL18_II SSO limit for FG packages in Table 29. Improved F_{BUFG} for -4 to 334 MHz in Table 33. Added references to 375 MHz performance via SCD 4103 in Table 33,Table 38, Table 39, and Table 40. Restored Units column to Table 44. Updated CCLK output maximum period in Table 46 to match minimum frequency in Table 47. Corrected BPI active clock edge in Figure 15 and Table 54.
05/28/08	1.7	Improved V_{CCAUXT} and V_{CCO2T} POR minimum in Table 5 and updated V_{CCO} POR levels in Figure 11. Clarified recommended V_{IN} in Table 8. Added reference to V_{CCAUX} in "Simultaneously Switching Output Guidelines". Added reference to Sample Window in Table 21. Removed DNA_RETENTION limit of 10 years in Table 15 since number of Read cycles is the only unique limit. Added references to UG332.
03/06/09	1.8	Changed typical quiescent current temperature from ambient to junction. Updated BPI configuration waveforms in Figure 15 and updated Table 55. Updated selected I/O standard DC characteristics. Added TIOPI and TIOPID in Table 22. Removed references to SCD 4103.
08/19/10	2.0	Added I_{IK} to Table 4. Updated V_{IN} in Table 8 and footnoted I_L in Table 9 to note potential leakage between pins of a differential pair. Clarified LVPECL notes to Table 13. Corrected symbols for TSUSPEND_GTS and TSUSPEND_GWE in Table 44.

Table 63: **Spartan-3A VQ100 Pinout *(Continued)***

2	IO_L12P_2/D1 (3S50A) IO_L11N_2/D1 (3S200A)	P52	DUAL
2	IP_2/VREF_2	P39	VREF
2	VCCO_2	P26	VCCO
2	VCCO_2	P45	VCCO
3	IO_L01N_3	P4	IO
3	IO_L01P_3	P3	IO
3	IO_L02N_3	P6	IO
3	IO_L02P_3	P5	IO
3	IO_L03N_3/LHCLK1	P10	CLK
3	IO_L03P_3/LHCLK0	P9	CLK
3	IO_L04N_3/IRDY2/LHCLK3	P13	CLK
3	IO_L04P_3/LHCLK2	P12	CLK
3	IO_L05N_3/LHCLK7	P16	CLK
3	IO_L05P_3/TRDY2/LHCLK6	P15	CLK
3	IO_L06N_3	P20	IO
3	IO_L06P_3	P19	IO
3	IP_3	P21	IP
3	IP_3/VREF_3	P7	VREF
3	VCCO_3	P11	VCCO
GND	GND	P14	GND
GND	GND	P18	GND
GND	GND	P42	GND
GND	GND	P47	GND
GND	GND	P58	GND
GND	GND	P63	GND
GND	GND	P69	GND
GND	GND	P74	GND
GND	GND	P8	GND
GND	GND	P80	GND
GND	GND	P87	GND
GND	GND	P91	GND
GND	GND	P95	GND
VCCAUX	DONE	P54	CONFIG
VCCAUX	PROG_B	P100	CONFIG
VCCAUX	TCK	P76	JTAG
VCCAUX	TDI	P2	JTAG
VCCAUX	TDO	P75	JTAG
VCCAUX	TMS	P1	JTAG
VCCAUX	VCCAUX	P22	VCCAUX
VCCAUX	VCCAUX	P55	VCCAUX
VCCAUX	VCCAUX	P92	VCCAUX
VCCINT	VCCINT	P17	VCCINT
VCCINT	VCCINT	P38	VCCINT
VCCINT	VCCINT	P66	VCCINT
VCCINT	VCCINT	P81	VCCINT

Table 63: **Spartan-3A VQ100 Pinout *(Continued)***

User I/Os by Bank

Table 64 indicates how the 68 available user-I/O pins are distributed between the four I/O banks on the VQ100 package.

Table 64: **User I/Os Per Bank for the XC3S50A and XC3S200A in the VQ100 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	15	3	1	1	3	7
Right	1	13	6	0	0	1	6
Bottom	2	26	2	0	19	1	4
Left	3	14	6	1	0	1	6
TOTAL		**68**	**17**	**2**	**20**	**6**	**23**

Footprint Migration Differences

The XC3S50A and XC3S200 have common VQ100 pinouts except for some differences in alignment of differential I/O pairs.

Differential I/O Alignment Differences

Some differential I/O pairs in the VQ100 on the XC3S50A FPGA are aligned differently than the corresponding pairs on the XC3S200A FPGAs, as shown in Table 65. All the mismatched pairs are in I/O Bank 2. These differences are indicated with the black diamond character (◆) in the footprint diagrams Figure 17 and Figure 18.

Table 65: **Differential I/O Differences in VQ100**

VQ100 Pin	Bank	XC3S50A	XC3S200A
P29	2	IIO_L04P_2/VS2	IO_L03N_2/VS2
P30		IO_L03N_2/VS1	IO_L04P_2/VS1
P33		IO_L06P_2	IO_L05N_2
P34		IO_L05N_2/D7	IO_L06P_2/D7
P51		IO_L11N_2/D0/DIN/ MISO	IO_L12P_2/D0/DIN/ MISO
P52		IO_L12P_2/D1	IO_L11N_2/D1

TQ144: 144-lead Thin Quad Flat Package

The XC3S50A is available in the 144-lead thin quad flat package, TQ144.

Table 66 lists all the package pins. They are sorted by bank number and then by pin name. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The XC3S50A does not support the address output pins for the Byte-wide Peripheral Interface (BPI) configuration mode.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 66: **Spartan-3A TQ144 Pinout**

Bank	Pin Name	Pin	Type
0	IO_0	P142	I/O
0	IO_L01N_0	P111	I/O
0	IO_L01P_0	P110	I/O
0	IO_L02N_0	P113	I/O
0	IO_L02P_0/VREF_0	P112	VREF
0	IO_L03N_0	P117	I/O
0	IO_L03P_0	P115	I/O
0	IO_L04N_0	P116	I/O
0	IO_L04P_0	P114	I/O
0	IO_L05N_0	P121	I/O
0	IO_L05P_0	P120	I/O
0	IO_L06N_0/GCLK5	P126	GCLK
0	IO_L06P_0/GCLK4	P124	GCLK
0	IO_L07N_0/GCLK7	P127	GCLK
0	IO_L07P_0/GCLK6	P125	GCLK
0	IO_L08N_0/GCLK9	P131	GCLK
0	IO_L08P_0/GCLK8	P129	GCLK
0	IO_L09N_0/GCLK11	P132	GCLK
0	IO_L09P_0/GCLK10	P130	GCLK
0	IO_L10N_0	P135	I/O
0	IO_L10P_0	P134	I/O
0	IO_L11N_0	P139	I/O
0	IO_L11P_0	P138	I/O
0	IO_L12N_0/PUDC_B	P143	DUAL
0	IO_L12P_0/VREF_0	P141	VREF
0	IP_0	P140	INPUT
0	IP_0/VREF_0	P123	VREF
0	VCCO_0	P119	VCCO
0	VCCO_0	P136	VCCO
1	IO_1	P79	I/O
1	IO_L01N_1/LDC2	P78	DUAL
1	IO_L01P_1/HDC	P76	DUAL
1	IO_L02N_1/LDC0	P77	DUAL
1	IO_L02P_1/LDC1	P75	DUAL
1	IO_L03N_1	P84	I/O
1	IO_L03P_1	P82	I/O
1	IO_L04N_1/RHCLK1	P85	RHCLK
1	IO_L04P_1/RHCLK0	P83	RHCLK
1	IO_L05N_1/TRDY1/RHCLK3	P88	RHCLK
1	IO_L05P_1/RHCLK2	P87	RHCLK
1	IO_L06N_1/RHCLK5	P92	RHCLK
1	IO_L06P_1/RHCLK4	P90	RHCLK
1	IO_L07N_1/RHCLK7	P93	RHCLK
1	IO_L07P_1/IRDY1/RHCLK6	P91	RHCLK
1	IO_L08N_1	P98	I/O
1	IO_L08P_1	P96	I/O
1	IO_L09N_1	P101	I/O
1	IO_L09P_1	P99	I/O
1	IO_L10N_1	P104	I/O
1	IO_L10P_1	P102	I/O
1	IO_L11N_1	P105	I/O
1	IO_L11P_1	P103	I/O
1	IP_1/VREF_1	P80	VREF
1	IP_1/VREF_1	P97	VREF
1	VCCO_1	P86	VCCO
1	VCCO_1	P95	VCCO
2	IO_2/MOSI/CSI_B	P62	DUAL
2	IO_L01N_2/M0	P38	DUAL
2	IO_L01P_2/M1	P37	DUAL
2	IO_L02N_2/CSO_B	P41	DUAL
2	IO_L02P_2/M2	P39	DUAL
2	IO_L03N_2/VS1	P44	DUAL
2	IO_L03P_2/RDWR_B	P42	DUAL
2	IO_L04N_2/VS0	P45	DUAL
2	IO_L04P_2/VS2	P43	DUAL
2	IO_L05N_2/D7	P48	DUAL

Table 66: **Spartan-3A TQ144 Pinout*(Continued)***

Bank	Pin Name	Pin	Type
2	IO_L05P_2	P46	I/O
2	IO_L06N_2/D6	P49	DUAL
2	IO_L06P_2	P47	I/O
2	IO_L07N_2/D4	P51	DUAL
2	IO_L07P_2/D5	P50	DUAL
2	IO_L08N_2/GCLK15	P55	GCLK
2	IO_L08P_2/GCLK14	P54	GCLK
2	IO_L09N_2/GCLK1	P59	GCLK
2	IO_L09P_2/GCLK0	P57	GCLK
2	IO_L10N_2/GCLK3	P60	GCLK
2	IO_L10P_2/GCLK2	P58	GCLK
2	IO_L11N_2/DOUT	P64	DUAL
2	IO_L11P_2/AWAKE	P63	PWR MGMT
2	IO_L12N_2/D3	P68	DUAL
2	IO_L12P_2/INIT_B	P67	DUAL
2	IO_L13N_2/D0/DIN/MISO	P71	DUAL
2	IO_L13P_2/D2	P69	DUAL
2	IO_L14N_2/CCLK	P72	DUAL
2	IO_L14P_2/D1	P70	DUAL
2	IP_2/VREF_2	P53	VREF
2	VCCO_2	P40	VCCO
2	VCCO_2	P61	VCCO
3	IO_L01N_3	P6	I/O
3	IO_L01P_3	P4	I/O
3	IO_L02N_3	P5	I/O
3	IO_L02P_3	P3	I/O
3	IO_L03N_3	P8	I/O
3	IO_L03P_3	P7	I/O
3	IO_L04N_3/VREF_3	P11	VREF
3	IO_L04P_3	P10	I/O
3	IO_L05N_3/LHCLK1	P13	LHCLK
3	IO_L05P_3/LHCLK0	P12	LHCLK
3	IO_L06N_3/IRDY2/LHCLK3	P16	LHCLK
3	IO_L06P_3/LHCLK2	P15	LHCLK
3	IO_L07N_3/LHCLK5	P20	LHCLK
3	IO_L07P_3/LHCLK4	P18	LHCLK
3	IO_L08N_3/LHCLK7	P21	LHCLK
3	IO_L08P_3/TRDY2/LHCLK6	P19	LHCLK
3	IO_L09N_3	P25	I/O
3	IO_L09P_3	P24	I/O
3	IO_L10N_3	P29	I/O
3	IO_L10P_3	P27	I/O
3	IO_L11N_3	P30	I/O
3	IO_L11P_3	P28	I/O
3	IO_L12N_3	P32	I/O
3	IO_L12P_3	P31	I/O
3	IP_L13N_3/VREF_3	P35	VREF
3	IP_L13P_3	P33	INPUT
3	VCCO_3	P14	VCCO
3	VCCO_3	P23	VCCO
GND	GND	P9	GND
GND	GND	P17	GND
GND	GND	P26	GND
GND	GND	P34	GND
GND	GND	P56	GND
GND	GND	P65	GND
GND	GND	P81	GND
GND	GND	P89	GND
GND	GND	P100	GND
GND	GND	P106	GND
GND	GND	P118	GND
GND	GND	P128	GND
GND	GND	P137	GND
VCCAUX	SUSPEND	P74	PWR MGMT
VCCAUX	DONE	P73	CONFIG
VCCAUX	PROG_B	P144	CONFIG
VCCAUX	TCK	P109	JTAG
VCCAUX	TDI	P2	JTAG
VCCAUX	TDO	P107	JTAG
VCCAUX	TMS	P1	JTAG
VCCAUX	VCCAUX	P36	VCCAUX
VCCAUX	VCCAUX	P66	VCCAUX
VCCAUX	VCCAUX	P108	VCCAUX
VCCAUX	VCCAUX	P133	VCCAUX
VCCINT	VCCINT	P22	VCCINT
VCCINT	VCCINT	P52	VCCINT
VCCINT	VCCINT	P94	VCCINT
VCCINT	VCCINT	P122	VCCINT

Table 69: **Spartan-3A FT256 Pinout (XC3S700A,**

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
3	IO_L16N_3	L2	I/O
3	IO_L16P_3/VREF_3	L1	VREF
3	IO_L18N_3	L3	I/O
3	IO_L18P_3	K4	I/O
3	IO_L19N_3	L4	I/O
3	IO_L19P_3	M3	I/O
3	IO_L20N_3	N1	I/O
3	IO_L20P_3	M1	I/O
3	IO_L22N_3	P1	I/O
3	IO_L22P_3/VREF_3	N2	VREF
3	IO_L23N_3	P2	I/O
3	IO_L23P_3	R1	I/O
3	IO_L24N_3	M4	I/O
3	IO_L24P_3	N3	I/O
3	IP_3	J4	INPUT
3	IP_3/VREF_3	G4	VREF
3	IP_3/VREF_3	J5	VREF
3	VCCO_3	D2	VCCO
3	VCCO_3	H2	VCCO
3	VCCO_3	M2	VCCO
GND	GND	A1	GND
GND	GND	A16	GND
GND	GND	B11	GND
GND	GND	B7	GND
GND	GND	C14	GND
GND	GND	C3	GND
GND	GND	E10	GND
GND	GND	E12	GND
GND	GND	E5	GND
GND	GND	F11	GND
GND	GND	F2	GND
GND	GND	F6	GND
GND	GND	F7	GND
GND	GND	F8	GND
GND	GND	F9	GND
GND	GND	G10	GND
GND	GND	G12	GND
GND	GND	G15	GND
GND	GND	G5	GND
GND	GND	G6	GND

Table 69: **Spartan-3A FT256 Pinout (XC3S700A,**

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
GND	GND	G8	GND
GND	GND	H11	GND
GND	GND	H5	GND
GND	GND	H7	GND
GND	GND	H9	GND
GND	GND	J10	GND
GND	GND	J6	GND
GND	GND	J8	GND
GND	GND	K11	GND
GND	GND	K12	GND
GND	GND	K2	GND
GND	GND	K5	GND
GND	GND	K7	GND
GND	GND	K9	GND
GND	GND	L10	GND
GND	GND	L11	GND
GND	GND	L15	GND
GND	GND	L6	GND
GND	GND	L8	GND
GND	GND	M12	GND
GND	GND	M5	GND
GND	GND	M8	GND
GND	GND	N10	GND
GND	GND	N7	GND
GND	GND	P14	GND
GND	GND	P3	GND
GND	GND	R10	GND
GND	GND	R6	GND
GND	GND	T1	GND
GND	GND	T16	GND
VCCAUX	SUSPEND	R16	PWRMGT
VCCAUX	DONE	T15	CONFIG
VCCAUX	PROG_B	A2	CONFIG
VCCAUX	TCK	A15	JTAG
VCCAUX	TDI	B1	JTAG
VCCAUX	TDO	B16	JTAG
VCCAUX	TMS	B2	JTAG
VCCAUX	VCCAUX	D6	VCCAUX
VCCAUX	VCCAUX	E11	VCCAUX
VCCAUX	VCCAUX	F12	VCCAUX

Differences Between XC3S200A/XC3S400A and XC3S700A/XC3S1400A

The XC3S700A and XC3S1400A FPGAs have several additional power and ground pins as compared to the XC3S200A and XC3S400A. Table 76 summarizes all the differences. All dedicated and dual-purpose configuration pins are in the same location.

Table 76: **Differences Between XC3S200A/XC3S400A and XC3S700A/XC3S1400A**

FT256 Ball	Bank	XC3S200A XC3S400A		XC3S700A XC3S1400A	
		Pin Name	**Type**	**Pin Name**	**Type**
F8	0	IO_L14P_0	I/O	GND	GND
D11	0	IO_L03N_0	I/O	IO_L06P_0	I/O
D10	0	IO_L06P_0	I/O	IO_L06N_0/ VREF_0	VREF
F7	0	IP_0	INPUT	GND	GND
F9	0	IP_0	INPUT	GND	GND
D12	0	IP_0	INPUT	IO_L03N_0	I/O
E9	0	IP_0/ VREF_0	INPUT	IO_L14P_0	I/O
D6	0	IP_0	INPUT	VCCAUX	VCCAUX
F10	0	IP_0	INPUT	VCCINT	VCCINT
E10	0	IO_L06N_0/ VREF_0	VREF	GND	GND
M13	1	IO_L05P_1	I/O	IP_1/ VREF_1	VREF
F11	1	IP_L25N_1	INPUT	GND	GND
H11	1	IP_L13N_1	INPUT	GND	GND
K11	1	IP_L04P_1	INPUT	GND	GND
G11	1	IP_L21N_1	INPUT	VCCINT	VCCINT
H10	1	IP_L13P_1	INPUT	VCCINT	VCCINT
J11	1	IP_L09N_1	INPUT	VCCINT	VCCINT
H14	1	IO_L14N_1/ RHCLK5	RHCLK	VCCAUX	VCCAUX
J14	1	IO_L14P_1/ RHCLK4	RHCLK	IP_1/ VREF_1	VREF
H12	1	VCCO_1	VCCO	IP_1/ VREF_1	VREF
G12	1	IP_L21P_1/ VREF_1	VREF	GND	GND
J10	1	IP_L09P_1/ VREF_1	VREF	GND	GND
K12	1	IP_L04N_1/ VREF_1	VREF	GND	GND
F12	1	IP_L25P_1/ VREF_1	VREF	VCCAUX	VCCAUX
M14	1	IO_L05N_1/ VREF_1	VREF	IP_1/ VREF_1	VREF
N7	2	IO_L07P_2	I/O	GND	GND
N10	2	IO_L13P_2	I/O	GND	GND
M10	2	IO_L13N_2	I/O	VCCAUX	VCCAUX
P6	2	IO_L07N_2	I/O	IP_2/ VREF_2	VREF
L8	2	IP_2	INPUT	GND	GND
L7	2	IP_2	INPUT	VCCINT	VCCINT
M9	2	VCCO_2	VCCO	IP_2/ VREF_2	VREF
L10	2	IP_2/ VREF_2	VREF	GND	GND
M8	2	IP_2/ VREF_2	VREF	GND	GND
L9	2	IP_2/ VREF_2	VREF	VCCINT	VCCINT
H5	3	IO_L10N_3	I/O	GND	GND
J6	3	IO_L17N_3	I/O	GND	GND
G3	3	IO_L09P_3	I/O	IO_L07N_3	I/O
J4	3	IO_L17P_3	I/O	IP_3	IP
H4	3	IO_L09N_3	I/O	VCCAUX	VCCAUX
H6	3	IO_L10P_3	I/O	VCCINT	VCCINT
N2	3	IO_L22P_3	I/O	IO_L22P_3/ VREF_3	VREF
G4	3	IO_L07N_3	I/O	IP_3/ VREF_3	VREF
G6	3	IP_L06P_3	INPUT	GND	GND
H7	3	IP_L13P_3	INPUT	GND	GND
K5	3	IP_L21P_3	INPUT	GND	GND
E4	3	IP_L04P_3	INPUT	IO_L04P_3	I/O
L5	3	IP_L25P_3	INPUT	VCCAUX	VCCAUX
J7	3	IP_L13N_3	INPUT	VCCINT	VCCINT
K6	3	IP_L21N_3	INPUT	VCCINT	VCCINT
J5	3	VCCO_3	VCCO	IP_3/ VREF_3	VREF
G5	3	IP_L06N_3/ VREF_3	VREF	GND	GND
L6	3	IP_L25N_3/ VREF_3	VREF	GND	GND
F4	3	IP_L04N_3/ VREF_3	VREF	IO_L04N_3	I/O

Table 81: **Spartan-3A FG400 Pinout** ***(Continued)***

Bank	Pin Name	FG400 Ball	Type
1	IP_1/VREF_1	N14	VREF
1	IP_L04N_1/VREF_1	P15	VREF
1	IP_L04P_1	P14	INPUT
1	IP_L11N_1/VREF_1	M15	VREF
1	IP_L11P_1	M16	INPUT
1	IP_L15N_1	M13	INPUT
1	IP_L15P_1/VREF_1	M14	VREF
1	IP_L19N_1	L13	INPUT
1	IP_L19P_1	L14	INPUT
1	IP_L23N_1	K14	INPUT
1	IP_L23P_1/VREF_1	K15	VREF
1	IP_L27N_1	J15	INPUT
1	IP_L27P_1	J16	INPUT
1	IP_L31N_1	J13	INPUT
1	IP_L31P_1/VREF_1	J14	VREF
1	IP_L35N_1	H14	INPUT
1	IP_L35P_1	H15	INPUT
1	IP_L39N_1	G14	INPUT
1	IP_L39P_1/VREF_1	G15	VREF
1	VCCO_1	D19	VCCO
1	VCCO_1	H16	VCCO
1	VCCO_1	K19	VCCO
1	VCCO_1	N16	VCCO
1	VCCO_1	T19	VCCO
2	IO_L01N_2/M0	V4	DUAL
2	IO_L01P_2/M1	U4	DUAL
2	IO_L02N_2/CSO_B	Y2	DUAL
2	IO_L02P_2/M2	W3	DUAL
2	IO_L03N_2	W4	I/O
2	IO_L03P_2	Y3	I/O
2	IO_L04N_2	R7	I/O
2	IO_L04P_2	T6	I/O
2	IO_L05N_2	U5	I/O
2	IO_L05P_2	V5	I/O
2	IO_L06N_2	U6	I/O
2	IO_L06P_2	T7	I/O
2	IO_L07N_2/VS2	U7	DUAL
2	IO_L07P_2/RDWR_B	T8	DUAL
2	IO_L08N_2	Y5	I/O
2	IO_L08P_2	Y4	I/O

Table 81: **Spartan-3A FG400 Pinout** ***(Continued)***

Bank	Pin Name	FG400 Ball	Type
2	IO_L09N_2/VS0	W6	DUAL
2	IO_L09P_2/VS1	V6	DUAL
2	IO_L10N_2	Y7	I/O
2	IO_L10P_2	Y6	I/O
2	IO_L11N_2	U9	I/O
2	IO_L11P_2	T9	I/O
2	IO_L12N_2/D6	W8	DUAL
2	IO_L12P_2/D7	V7	DUAL
2	IO_L13N_2	V9	I/O
2	IO_L13P_2	V8	I/O
2	IO_L14N_2/D4	T10	DUAL
2	IO_L14P_2/D5	U10	DUAL
2	IO_L15N_2/GCLK13	Y9	GCLK
2	IO_L15P_2/GCLK12	W9	GCLK
2	IO_L16N_2/GCLK15	W10	GCLK
2	IO_L16P_2/GCLK14	V10	GCLK
2	IO_L17N_2/GCLK1	V11	GCLK
2	IO_L17P_2/GCLK0	Y11	GCLK
2	IO_L18N_2/GCLK3	V12	GCLK
2	IO_L18P_2/GCLK2	U11	GCLK
2	IO_L19N_2	R12	I/O
2	IO_L19P_2	T12	I/O
2	IO_L20N_2/MOSI/CSI_B	W12	DUAL
2	IO_L20P_2	Y12	I/O
2	IO_L21N_2	W13	I/O
2	IO_L21P_2	Y13	I/O
2	IO_L22N_2/DOUT	V13	DUAL
2	IO_L22P_2/AWAKE	U13	PWR MGMT
2	IO_L23N_2	R13	I/O
2	IO_L23P_2	T13	I/O
2	IO_L24N_2/D3	W14	DUAL
2	IO_L24P_2/INIT_B	Y14	DUAL
2	IO_L25N_2	T14	I/O
2	IO_L25P_2	V14	I/O
2	IO_L26N_2/D1	V15	DUAL
2	IO_L26P_2/D2	Y15	DUAL
2	IO_L27N_2	T15	I/O
2	IO_L27P_2	U15	I/O
2	IO_L28N_2	W16	I/O

Table 81: **Spartan-3A FG400 Pinout*(Continued)***

Bank	Pin Name	FG400 Ball	Type
3	IO_L34P_3	U1	I/O
3	IO_L36N_3	T4	I/O
3	IO_L36P_3	R5	I/O
3	IO_L37N_3	V2	I/O
3	IO_L37P_3	V1	I/O
3	IO_L38N_3	W2	I/O
3	IO_L38P_3	W1	I/O
3	IP_3	H7	INPUT
3	IP_L04N_3/VREF_3	G6	VREF
3	IP_L04P_3	G7	INPUT
3	IP_L11N_3/VREF_3	J7	VREF
3	IP_L11P_3	J8	INPUT
3	IP_L15N_3	K7	INPUT
3	IP_L15P_3	K8	INPUT
3	IP_L19N_3	K5	INPUT
3	IP_L19P_3	K6	INPUT
3	IP_L23N_3	L6	INPUT
3	IP_L23P_3	L7	INPUT
3	IP_L27N_3	M7	INPUT
3	IP_L27P_3	M8	INPUT
3	IP_L31N_3	N7	INPUT
3	IP_L31P_3	M6	INPUT
3	IP_L35N_3	N6	INPUT
3	IP_L35P_3	P5	INPUT
3	IP_L39N_3/VREF_3	P7	VREF
3	IP_L39P_3	P6	INPUT
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	N5	VCCO
3	VCCO_3	U2	VCCO
GND	GND	A1	GND
GND	GND	A11	GND
GND	GND	A20	GND
GND	GND	B6	GND
GND	GND	B14	GND
GND	GND	C3	GND
GND	GND	C18	GND
GND	GND	D9	GND
GND	GND	E5	GND
GND	GND	E12	GND
GND	GND	F15	GND
GND	GND	G2	GND
GND	GND	G19	GND
GND	GND	H8	GND
GND	GND	H13	GND
GND	GND	J9	GND
GND	GND	J11	GND
GND	GND	K1	GND
GND	GND	K10	GND
GND	GND	K12	GND
GND	GND	K17	GND
GND	GND	L4	GND
GND	GND	L9	GND
GND	GND	L11	GND
GND	GND	L20	GND
GND	GND	M10	GND
GND	GND	M12	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N13	GND
GND	GND	P2	GND
GND	GND	P19	GND
GND	GND	R6	GND
GND	GND	R9	GND
GND	GND	T16	GND
GND	GND	U12	GND
GND	GND	V3	GND
GND	GND	V18	GND
GND	GND	W7	GND
GND	GND	W15	GND
GND	GND	Y1	GND
GND	GND	Y10	GND
GND	GND	Y20	GND
VCCAUX	SUSPEND	R15	PWR MGMT
VCCAUX	DONE	W19	CONFIG
VCCAUX	PROG_B	D5	CONFIG
VCCAUX	TCK	A19	JTAG
VCCAUX	TDI	F5	JTAG

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
2	IO_L10P_2	Y7	I/O
2	IO_L11N_2/VS0	Y8	DUAL
2	IO_L11P_2/VS1	W8	DUAL
2	IO_L12N_2	AB8	I/O
2	IO_L12P_2	AA8	I/O
2	IO_L13N_2	Y10	I/O
2	IO_L13P_2	V10	I/O
2	IO_L14N_2/D6	AB9	DUAL
2	IO_L14P_2/D7	Y9	DUAL
2	IO_L15N_2	AB10	I/O
2	IO_L15P_2	AA10	I/O
2	IO_L16N_2/D4	AB11	DUAL
2	IO_L16P_2/D5	Y11	DUAL
2	IO_L17N_2/GCLK13	V11	GCLK
2	IO_L17P_2/GCLK12	U11	GCLK
2	IO_L18N_2/GCLK15	Y12	GCLK
2	IO_L18P_2/GCLK14	W12	GCLK
2	IO_L19N_2/GCLK1	AB12	GCLK
2	IO_L19P_2/GCLK0	AA12	GCLK
2	IO_L20N_2/GCLK3	U12	GCLK
2	IO_L20P_2/GCLK2	V12	GCLK
2	IO_L21N_2	Y13	I/O
2	IO_L21P_2	AB13	I/O
2	IO_L22N_2/MOSI/CSI_B	AB14	DUAL
2	IO_L22P_2	AA14	I/O
2	IO_L23N_2	Y14	I/O
2	IO_L23P_2	W13	I/O
2	IO_L24N_2/ DOUT	AA15	DUAL
2	IO_L24P_2/AWAKE	AB15	PWR MGMT
2	IO_L25N_2	Y15	I/O
2	IO_L25P_2	W15	I/O
2	IO_L26N_2/D3	U13	DUAL
2	IO_L26P_2/INIT_B	V13	DUAL
2	IO_L27N_2	Y16	I/O
2	IO_L27P_2	AB16	I/O
2	IO_L28N_2/D1	Y17	DUAL
2	IO_L28P_2/D2	AA17	DUAL
2	IO_L29N_2	AB18	I/O
2	IO_L29P_2	AB17	I/O

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
2	IO_L30N_2	V15	I/O
2	IO_L30P_2	V14	I/O
2	IO_L31N_2	V16	I/O
2	IO_L31P_2	W16	I/O
2	IO_L32N_2	AA19	I/O
2	IO_L32P_2	AB19	I/O
2	IO_L33N_2	V17	I/O
2	IO_L33P_2	W18	I/O
2	IO_L34N_2	W17	I/O
2	IO_L34P_2	Y18	I/O
2	IO_L35N_2	AA21	I/O
2	IO_L35P_2	AB21	I/O
2	IO_L36N_2/CCLK	AA20	DUAL
2	IO_L36P_2/D0/DIN/MISO	AB20	DUAL
2	IP_2	P12	INPUT
2	IP_2	R10	INPUT
2	IP_2	R11	INPUT
2	IP_2	R9	INPUT
2	IP_2	T13	INPUT
2	IP_2	T14	INPUT
2	IP_2	T9	INPUT
2	IP_2	U10	INPUT
2	IP_2	U15	INPUT
2	***XC3S1400A:*** IP_2 ***XC3S700A:*** N.C. (◆)	U16	INPUT
2	***XC3S1400A:*** IP_2 ***XC3S700A:*** N.C. (◆)	U7	INPUT
2	IP_2	U8	INPUT
2	IP_2	V7	INPUT
2	IP_2/VREF_2	R12	VREF
2	IP_2/VREF_2	R13	VREF
2	IP_2/VREF_2	R14	VREF
2	IP_2/VREF_2	T10	VREF
2	IP_2/VREF_2	T11	VREF
2	IP_2/VREF_2	T15	VREF
2	IP_2/VREF_2	T16	VREF
2	IP_2/VREF_2	T7	VREF
2	***XC3S1400A:*** IP_2/VREF_2 ***XC3S700A:*** N.C. (◆)	T8	VREF
2	IP_2/VREF_2	V8	VREF
2	VCCO_2	AA13	VCCO

Right Half of FG676 Package (Top View)

14	15	16	17	18	19	20	21	22	23	24	25	26	
I/O L26N_0 GCLK7	I/O L23N_0	GND	INPUT	I/O L18N_0	I/O L15N_0	I/O L14N_0	GND	I/O L07N_0	INPUT	N.C. ◆	TCK	GND	A
I/O L26P_0 GCLK6	I/O L23P_0	VCCO_0	I/O L19N_0	I/O L18P_0	I/O L15P_0	I/O L14P_0 VREF_0	I/O L09N_0	VCCO_0	I/O L07P_0	N.C. ◆	INPUT L65N_1	INPUT L65P_1 VREF_1	B
GND	I/O L22N_0	I/O L21N_0	I/O L19P_0	I/O L17N_0	GND	I/O L11N_0	I/O L09P_0	I/O L05N_0	I/O L06N_0	GND	I/O L63N_1 A23	I/O L63P_1 A22	C
INPUT VREF_0	INPUT	I/O L22P_0	I/O L21P_0	I/O L17P_0	INPUT	I/O L11P_0	I/O L10N_0	I/O L05P_0	I/O L06P_0	I/O L61N_1	I/O L61P_1	I/O L60N_1	D
I/O L24P_0	I/O L20N_0 VREF_0	VCCAUX	I/O L13N_0	INPUT	VCCO_0	INPUT	I/O L10P_0	VCCAUX	TDO	I/O L56P_1	VCCO_1	I/O L60P_1	E
I/O L24N_0	I/O L20P_0	GND	I/O L13P_0	N.C. ◆	I/O L02N_0	I/O L01N_0	GND	I/O L58P_1 VREF_1	I/O L56N_1	I/O L54N_1	I/O L54P_1	GND	F
INPUT	I/O L16P_0	INPUT	I/O L08N_0	N.C. ◆	I/O L02P_0 VREF_0	I/O L01P_0	I/O L64N_1 A25	I/O L58N_1	I/O L51P_1	I/O L51N_1	INPUT L52N_1 VREF_1	INPUT L52P_1	G
GND	I/O L16N_0	VCCO_0	I/O L08P_0	INPUT	GND	I/O L64P_1 A24	I/O L62N_1 A21	VCCO_1	INPUT L48P_1	INPUT L48N_1	INPUT L44N_1	INPUT L44P_1 VREF_1	H
I/O L25N_0 GCLK5	INPUT	I/O L12P_0	INPUT VREF_0	VCCAUX	I/O L59P_1	I/O L59N_1	I/O L62P_1 A20	I/O L49N_1	I/O L49P_1	GND	I/O L43N_1 A19	I/O L43P_1 A18	J
I/O L25P_0 GCLK4	VCCINT	I/O L12N_0	GND	I/O L57N_1	I/O L57P_1	I/O L53N_1	I/O L50N_1	I/O L46N_1	I/O L46P_1	INPUT L40P_1	I/O L41P_1	I/O L41N_1	K
VCCINT	GND	VCCINT	I/O L55N_1	I/O L55P_1	VCCO_1	I/O L53P_1	GND	I/O L50P_1	INPUT L40N_1	I/O L38P_1 A12	VCCO_1	GND	L
GND	VCCINT	GND	VCCINT	I/O L47N_1	I/O L47P_1	I/O L42N_1 A17	I/O L45P_1	I/O L45N_1	I/O L38N_1 A13	INPUT L36P_1 VREF_1	I/O L35N_1 A11	I/O L35P_1 A10	M
VCCINT	GND	VCCINT	I/O L39N_1 A15	I/O L39P_1 A14	I/O L34N_1 RHCLK7	I/O L42P_1 A16	I/O L37N_1	VCCO_1	INPUT L36N_1	I/O L33N_1 RHCLK5	INPUT L32N_1	INPUT L32P_1	N
VCCINT	VCCINT	GND	VCCAUX	I/O L34P_1 IRDY1 RHCLK6	GND	I/O L30N_1 RHCLK1	I/O L30P_1 RHCLK0	I/O L37P_1	I/O L33P_1 RHCLK4	GND	I/O L31N_1 TRDY1 RHCLK3	I/O L31P_1 RHCLK2	P
VCCINT	GND	VCCINT	I/O L27N_1 A7	I/O L27P_1 A6	I/O L22P_1	I/O L22N_1	I/O L25P_1 A2	I/O L25N_1 A3	INPUT L28P_1 VREF_1	INPUT L28N_1	I/O L29P_1 A8	I/O L29N_1 A9	R
GND	VCCINT	GND	I/O L17N_1	I/O L17P_1	VCCO_1	I/O L14N_1	GND	VCCAUX	I/O L26P_1 A4	I/O L26N_1 A5	VCCO_1	GND	T
VCCAUX	I/O L35N_2	I/O L42N_2	GND	I/O L12N_1	I/O L12P_1	I/O L10N_1	I/O L14P_1	I/O L21N_1	I/O L23P_1	I/O L23N_1 VREF_1	INPUT L24P_1	INPUT L24N_1 VREF_1	U
I/O L31P_2	I/O L35P_2	I/O L42P_2	I/O L46N_2	I/O L08P_1	I/O L08N_1	SUSPEND	I/O L10P_1	I/O L18N_1	I/O L21P_1	I/O L19P_1	I/O L19N_1	INPUT L20N_1 VREF_1	V
GND	I/O L31N_2	VCCO_2	I/O L46P_2	N.C. ◆	GND	I/O L04P_1	I/O L04N_1	VCCO_1	I/O L18P_1	GND	INPUT L16P_1	INPUT L20P_1	W
I/O L27P_2 GCLK0	I/O L34N_2 D3	INPUT 2 VREF_2	I/O L43N_2	N.C. ◆	N.C. ◆	I/O L01P_1 HDC	I/O L01N_1 LDC2	I/O L13P_1	I/O L13N_1	I/O L15P_1	I/O L15N_1	INPUT L16N_1	Y
I/O L27N_2 GCLK1	I/O L34P_2 INIT_B	GND	I/O L43P_2	I/O L47N_2	INPUT	INPUT VREF_2	GND	I/O L09P_1	I/O L09N_1	I/O L11P_1	I/O L11N_1	GND	AA
VCCO_2	I/O L30N_2 MOSI CSI_B	I/O L38N_2	INPUT	I/O L47P_2	VCCO_2	INPUT	DONE	VCCAUX	I/O L07P_1	I/O L07N_1 VREF_1	VCCO_1	I/O L06N_1	AB
I/O L29N_2	I/O L30P_2	I/O L38P_2	INPUT	INPUT	I/O L40N_2	I/O L41N_2	I/O L45N_2	N.C. ◆	I/O L03P_1 A0	I/O L03N_1 A1	I/O L05N_1	I/O L06P_1	AC
I/O L29P_2	I/O L32P_2 AWAKE	INPUT	I/O L33N_2	GND	I/O L40P_2	I/O L41P_2	I/O L44N_2	I/O L45P_2	N.C. ◆	GND	I/O L02N_1 LDC0	I/O L05P_1	AD
I/O L28N_2 GCLK3	I/O L32N_2 DOUT	VCCO_2	I/O L33P_2	I/O L36N_2 D1	I/O L37N_2	I/O L39N_2	I/O L44P_2	VCCO_2	I/O L48N_2	I/O L52N_2 CCLK	I/O L51N_2	I/O L02P_1 LDC1	AE
I/O L28P_2 GCLK2	INPUT VREF_2	GND	INPUT VREF_2	I/O L36P_2 D2	I/O L37P_2	I/O L39P_2	GND	INPUT VREF_2	I/O L48P_2	I/O L52P_2 D0 DIN/MISO	I/O L51P_2	GND	AF